## **High-Current Complementary Silicon Transistors**

 $\ldots$  for use as output devices in complementary general purpose amplifier applications.

- High DC Current Gain hFE = 1000 (Min) @ IC = 25 Adc hFE = 400 (Min) @ IC = 50 Adc
- Curves to 100 A (Pulsed)
- Diode Protection to Rated IC
- Monolithic Construction with Built-In Base-Emitter Shunt Resistor
- Junction Temperature to +200°C

#### MAXIMUM RATINGS

Rating	Symbol	MJ11028 MJ11029	MJ11030 MJ11031	MJ11032 MJ11033	Unit
Collector–Emitter Voltage	VCEO	60	90	120	Vdc
Collector-Base Voltage	V <sub>CB</sub>	60	90	120	Vdc
Emitter-Base Voltage	V <sub>EB</sub>	5			Vdc
Collector Current — Continuous Peak	IC ICM	50 100			Adc
Base Current — Continuous	۱ <sub>B</sub>	2			Adc
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C @ T <sub>C</sub> = 100°C	PD	300 1.71			Watts W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +200			°C

## NPN MJ11028 MJ11030 MJ11032\* PNP MJ11029 MJ11031 MJ11033\*

50 AMPERE COMPLEMENTARY SILICON DARLINGTON POWER TRANSISTORS 60–120 VOLTS 300 WATTS

# CASE 197A-05 TO-204AE (TO-3)

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Lead Temperature for Soldering Purposes for $\leq$ 10 seconds	ΤL	275	°C
Thermal Resistance Junction to Case	R <sub>θJC</sub>	0.584	°C



Figure 1. Darlington Circuit Schematic

Preferred devices are Motorola recommended choices for future use and best overall value.



#### MJ11028 MJ11030 MJ11032 MJ11029 MJ11031 MJ11033

#### **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					•
Collector-Emitter Breakdown Voltage (1)	MJ11028, MJ11029	V(BR)CEO	60	—	Vdc
$(I_{C} = 1 \ 00 \ mAdc, I_{B} = 0)$	MJ11030, MJ11031 MJ11032, MJ11033		90 120		
Collector–Emitter Leakage Current		ICER			mAdc
(V <sub>CE</sub> = 60 Vdc, R <sub>BE</sub> = 1 k ohm)	MJ11028, MJ11029		—	2	
(V <sub>CE</sub> = 90 Vdc, R <sub>BE</sub> = 1 k ohm)	MJ11030, MJ11031		—	2	
(V <sub>CE</sub> = 120 Vdc, R <sub>BE</sub> = 1 k ohm)	MJ11032, MJ11033		-	2	
$(V_{CE} = 60 \text{ Vdc}, R_{BE} = 1 \text{ k ohm}, T_{C} = 150^{\circ}\text{C})$	MJ11028, MJ11029		—	10	
$(V_{CE} = 90 \text{ Vdc}, R_{BE} = 1 \text{ k ohm}, T_{C} = 150^{\circ}\text{C})$	MJ11030, MJ11031		—	10	
$(V_{CE} = 120 \text{ Vdc}, R_{BE} = 1 \text{ k ohm}, T_{C} = 150^{\circ}\text{C})$	MJ11032, MJ11033		—	10	
Emitter Cutoff Current ( $V_{BE} = 5 \text{ Vdc}, I_{C} = 0$ )		IEBO		5	mAdc
Collector–Emitter Leakage Current ( $V_{CE} = 50$ Vdc, $I_B = 0$ )		ICEO		2	mAdc
ON CHARACTERISTICS (1)					
DC Current Gain		hFE			—
$(I_C = 25 \text{ Adc}, V_{CE} = 5 \text{ Vdc})$			1 k	18 k	
$(I_C = 50 \text{ Adc}, V_{CE} = 5 \text{ Vdc})$			400	—	
Collector–Emitter Saturation Voltage		V <sub>CE(sat)</sub>			Vdc
(I <sub>C</sub> = 25 Adc, I <sub>B</sub> = 250 mAdc)		- ()	—	2.5	
$(I_{C} = 50 \text{ Adc}, I_{B} = 500 \text{ mAdc})$			—	3.5	
Base-Emitter Saturation Voltage		V <sub>BE(sat)</sub>			Vdc
$(I_{C} = 25 \text{ Adc}, I_{B} = 200 \text{ mAdc})$		、 /	—	3.0	
$(I_{C} = 50 \text{ Adc}, I_{B} = 300 \text{ mAdc})$			—	4.5	

(1) Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2.0%.





There are two limitations on the power–handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on  $T_{J(pk)} = 200^{\circ}C$ ;  $T_C$  is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.



#### MJ11028 MJ11030 MJ11032 MJ11029 MJ11031 MJ11033

### PACKAGE DIMENSIONS



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